

**Office of the Director  
Directorate of Technical Education, Vocational and Industrial  
Training Himachal Pradesh, Sunder Nagar**

**Invitation for Bids No.: GP001/2023**

**Date: 05/04/2023**

Loan/Grant No. and Title: Loan No.: 3573-IND/ Himachal Pradesh Skill Development Project.

Deadline for submission of bids: **08/05/2023** upto 01:15 PM

**Contract Package (NCB) No. and Title: Supply of Solar Panels for Govt. Polytechnic (Women) Rehan District Kangra Himachal Pradesh; HPSPDP-DOTE/WP/24.**

1. India has received a loan from the Asian Development Bank (ADB) towards the cost of "Himachal Pradesh Skill Development Project" and it intends to apply part of the proceeds of this financing to the payment under the Contract Package named above. Bidding is open to Bidders from eligible source countries of ADB.
2. The "Directorate of Technical Education, Vocational and Industrial Training, Himachal Pradesh", represented by the Director ("The Purchaser") invites sealed bids from eligible Bidders for the supply of Solar Panels for **Government Polytechnic (Women) Rehan District Kangra Himachal Pradesh.**
3. **National Competitive Bidding** will be conducted in accordance with ADB's Single-stage: Two-envelope bidding procedure and is open to all Bidders from eligible countries as described in the Bidding Document.
4. Only eligible Bidders with the following key qualifications should participate in this bidding:

<b>Package No.</b>	<b>Contractual experience:</b> Successful completion as main supplier within the last three (3) years, of at least One (1) contract with nature, and complexity similar to the scope of supply described in Section 6 (Schedule of Supply). The contract value is indicated below:	<b>Average Annual Turnover:</b> Minimum average annual turnover as indicated below calculated as total payments received by the Bidder for contracts completed or under execution over the last three (3) years. The Average Annual Turnover is indicated below:
HPSPDP- DOTE/WP/24	INR 101.00 Lakhs	INR 253.00 Lakhs

However, for complete eligibility and qualification requirements, respective bid document should be referred.

5. To obtain further information and inspect the bidding documents, Bidders should contact:

Attention: **The Director, Directorate of Technical Education, Vocational**

**and Industrial Training Circular Road, Lalit Chowk, Sunder Nagar,  
District: Mandi, Himachal Pradesh ZIP code: 175018; Country: India.**  
Telephone & Fax: 01907-266120; 266722, E-mail address: [techedu-hp@nic.in](mailto:techedu-hp@nic.in)

6. To purchase the bidding documents in English language, eligible Bidders should write or visit at the office of the Purchaser at address stated above and pay **a non- refundable fee of INR 10,000 for the bidding document** in the form of **Bank Demand Draft**.

In case of written request, the document will be sent by post and no liability will be accepted, for loss or late delivery.

The bidders who wish to receive the bidding document by post/courier shall have to pay **for the bidding document** an additional amount of INR 3,000/- for delivery within India or USD 250 for delivery outside India. The method of payment will be through bank demand draft payable at Sundernagar, Himachal Pradesh, India.

The eligible bidders may otherwise download the bidding document for English language from the website: <http://techedu.hp.gov.in/>, such bidders shall be required to submit **INR 10,000** with their bid **for the bidding document** in the form of **Bank demand draft** in the name of the Director Technical Education, HP, Sundernagar towards cost of bidding document.

7. Deliver your bid
  - To the address above
  - On or before the deadline: **08/05/2023 at 01:15 PM.**
  - Together with a Bid Security as described in the Bidding Document.
8. Bids will be opened on **08/05/2023 at 02:30 PM** in the presence of Bidders' representatives who choose to attend.
9. The Purchaser will not be responsible for any cost or expenses incurred by the bidder in connection with the preparation or delivery of bids.

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Director